

# SMB1N-D630

- Red High Power LED
- 630 nm, 290 mW
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 1.0 mm
- Viewing Angle: 128°

### Description





2017 / 05

**SMB1N-D630** is a surface mount AlGaInP High Power LED with a typical peak wavelength of **630 nm** and radiation of **290 mW**. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

### Maximum Ratings (T<sub>CASE</sub>=25°C)

Deveneter	Currench of	Va	1114		
Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		1000	mW	
Forward Current	I <sub>F</sub>		350	mA	
Pulse Forward Current *1	IFP		500	mA	
Reverse Voltage	V <sub>R</sub>		5	V	
Thermal Resistance	RTHJA		10	K/W	
Junction Temperature	$T_J$		120	°C	
Operating Temperature	TCASE	- 40	+ 100	°C	
Storage Temperature	Tstg	- 40	+ 100	°C	
Lead Solder Temperature *2	T <sub>SLD</sub>		+ 250	°C	

\*1 duty=1%, pulse width = 10  $\mu$ s

\*2 must be completed within 5 seconds

### Electro-Optical Characteristics (T<sub>CASE</sub>=25°C)

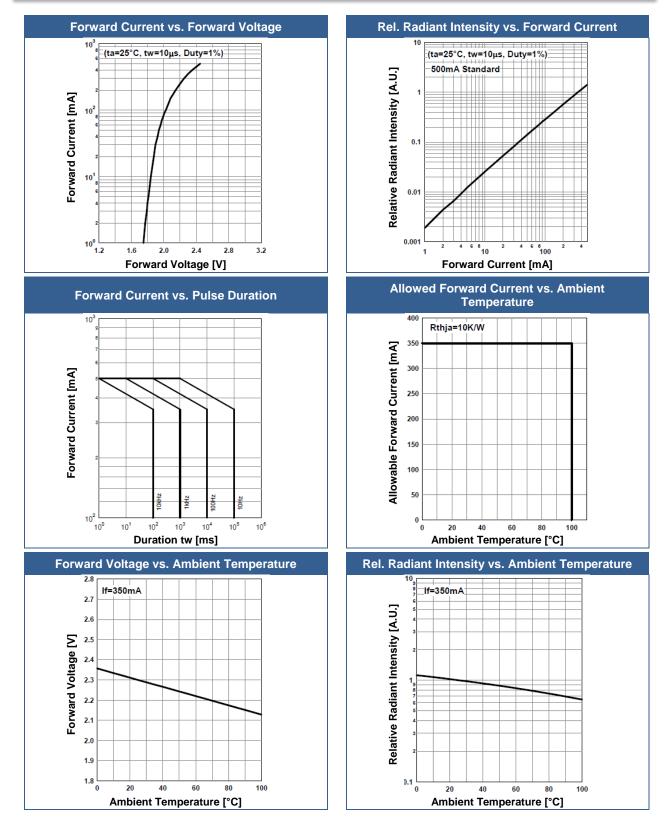
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λP	I⊧=350mA	620		640	nm
Dominant Wavelength	λD	I⊧=350mA		620		nm
Half Width	$\Delta \lambda$	I⊧=350mA		15		nm
	VF	I⊧=350mA		2.3	2.8	V
Forward Voltage	VFP	IFP=500mA		2.5		V
Radiated Power *1	Po	I⊧=350mA		190		mW
Radiated Fower		IFP=500mA		410		IIIVV
Radiant Intensity *2	IE	I⊧=350mA		96		mW/sr
Radiant intensity		IFP=500mA		130		11100/51
Luminous Flux	$\phi_V$	I⊧=350mA		50		lm
Viewing Angle	φ	I <sub>F</sub> =100mA		128		deg.
Rise Time	t <sub>R</sub>	I <sub>F</sub> =350mA		80		ns
Fall Time	t⊢	I <sub>F</sub> =350mA		40		ns

\*1 measured by S3584-08

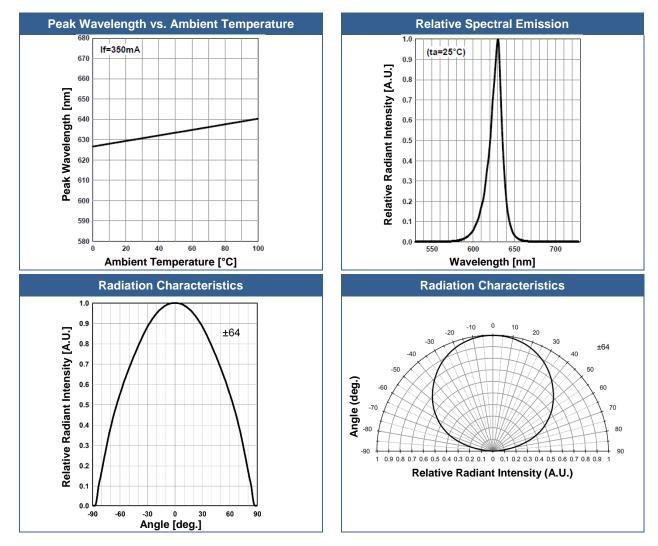
\*2 measured by CIE127-2007 Condition B



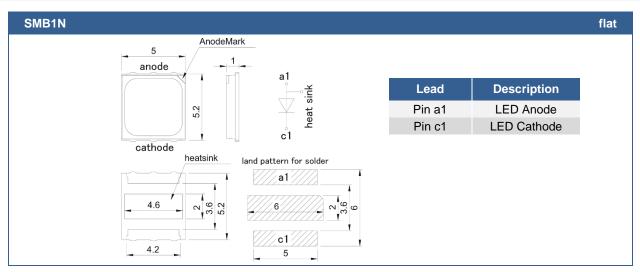
## Typical Performance Curves







### **Outline Dimensions**



All Dimensions in mm



### Precautions

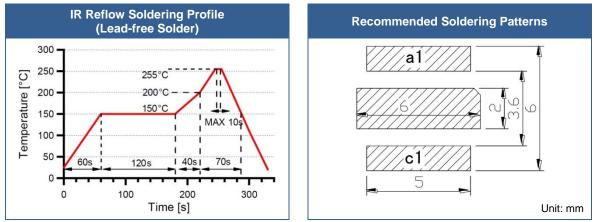
#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

#### **Recommended soldering conditions:**

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### **Cleaning:**

#### Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

#### **Static Electricity:**

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### **Radiation:**

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

#### **Operation:**

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.



### **Revisions History**

Rel.	Rel. Date	Chapter	Modification	Page
	2017 05	-	released	-

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The above specifications are for reference purpose only and subjected to change without prior notice